

ASMT-TxBM-Nxxxx

Surface Mount LED Indicator



Data Sheet



Lead (Pb) Free
RoHS 6 fully
compliant



Description

Avago Technologies' ASMT-TxBM-Nxxxx Mini PLCC-2 SMT LEDs are designed specifically for use in Interior Automotive applications. They have a wide viewing angle of 120° making them ideally suited for instrument cluster panel, push button, HVAC and ambient decorative lighting applications in automotive interiors.

The LEDs are packed in EIA-compliant tape and reel to facilitate easy pick and place assembly. Every reel will be shipped in single intensity and color bin, to provide close uniformity.

Features

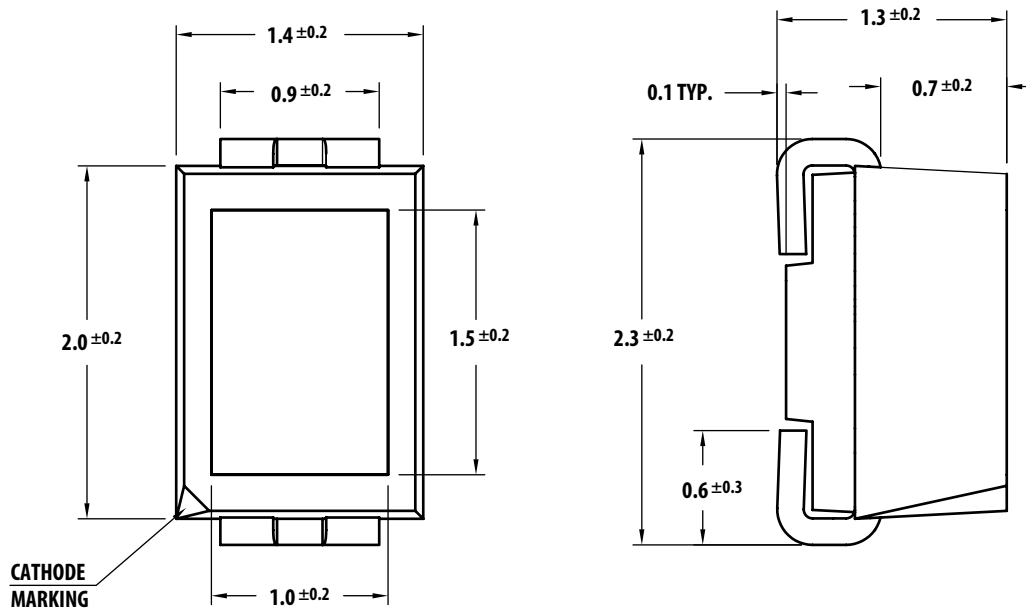
- Industry standard Mini PLCC-2
- High reliability LED package
- High brightness using InGaN dice technologies
- High optical efficiency
- Wide vertical viewing angle at 120°
- Available is 8mm carrier tape on 7-inch reel
- Stable & consistent performance with minimum degradation
- JEDEC MSL 2

Applications

- Interior automotive
 - Instrument panel backlighting
 - Central console backlighting
 - Navigation and audio system backlighting
 - Push button backlighting
 - Ambient illumination
 - Car puddle lighting

CAUTION: ASMT-TXBM-Nxxxx LED is Class 1B ESD sensitive. Please observe appropriate precautions during handling and processing. Refer to Avago Application Note AN-1142 for additional details.

Package Dimensions



Notes:

1. All dimensions in millimeters.
2. Terminal Finish: Ag plating.
3. Encapsulation material: Silicone resin.

Figure 1. Package Drawing

Table 1. Device Selection Guide

Color	Part Number	Min. I_v (mcd)	Typ. I_v (mcd)	Max. I_v (mcd)	Test Current (mA)	Dice Technology
Blue	ASMT-TBBM-NP902	56.0	100.0	180.0	20	InGaN
Green	ASMT-TGBM-NT502	285.0	480.0	900.0	20	InGaN
Green	ASMT-TGBM-NU3B2	450	-	900	20	InGaN

Notes:

1. The luminous intensity I_v is measured at the mechanical axis of the lamp package. The actual peak of the spatial radiation pattern may not be aligned with this axis.
2. Tolerance = $\pm 12\%$

Part Numbering System

ASMT – T X₁ B M – N X₂ X₃ X₄ X₅

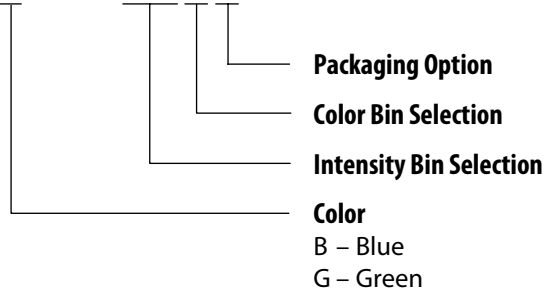


Table 2. Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$)

Parameters	ASMT-TBBM-Nxxxx	ASMT-TGBM-Nxxxx
DC Forward Current ^[1]	20 mA	
Peak Forward Current ^[2]	100 mA	
Power Dissipation	72 mW	
Reverse Voltage, V_R @ 10 μA	Not Recommended for Reverse Bias	
Junction Temperature	110°C	125°C
Operating Temperature	-40°C to +100°C	
Storage Temperature	-40°C to +100°C	

Notes:

1. Derate Linearly as shown in Figure 6.
2. Duty Factor = 10%, Frequency = 1kHz

Table 3. Optical Characteristics ($T_J = 25^\circ\text{C}$)

Color	Part Number	Dice Technology	Peak Wavelength	Dominant Wavelength ^[1]	Vertical Viewing Angle $2\theta_{1/2}$ ^[2]	Total Flux / Luminous Intensity
			λ_{PEAK} (nm)	λ_D (nm)	(Degrees)	Φ_V (lm) / I_V (cd)
			Typ.	Typ.	Typ.	Typ.
Blue	ASMT-TBBM-Nxx02	InGaN	459.5	465.0	120	2.8
Green	ASMT-TGBM-Nxx02	InGaN	516.0	522.0	120	2.8

Notes:

1. The dominant wavelength, λ_D , is derived from the CIE Chromaticity diagram and represents the color of the device.
2. $\theta_{1/2}$ is the off-axis angle where the luminous intensity is $1/2$ the peak intensity.

Table 4. Electrical Characteristics ($T_J = 25^\circ\text{C}$)

Part Number	Forward Voltage V_F (Volts) @ $I_F = 20$ mA			Thermal Resistance
	Min.	Typ.	Max.	$R\theta_{JP}$ ($^\circ\text{C}/\text{W}$)
ASMT-TBBM-Nxxx2	2.8	3.2	3.6	230
ASMT-TGBM-Nxxx2	2.9	3.3	4.0	230

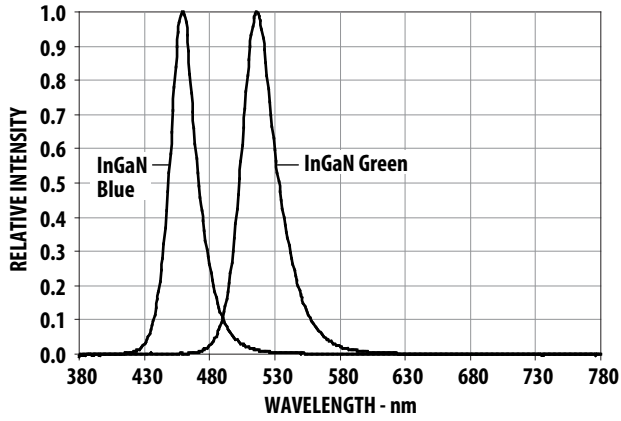


Figure 2. Relative Intensity Vs. Wavelength

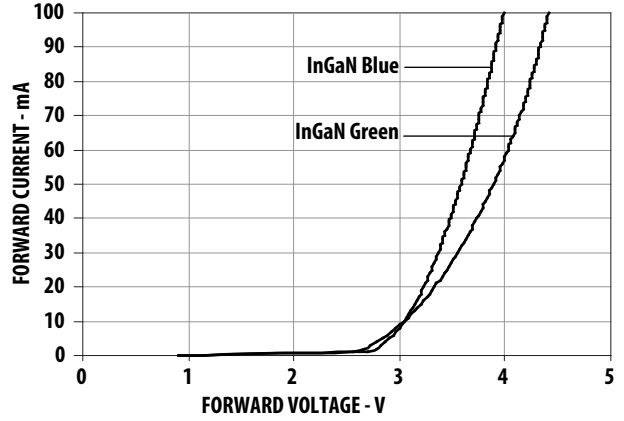


Figure 3. Forward Current vs. Forward Voltage.

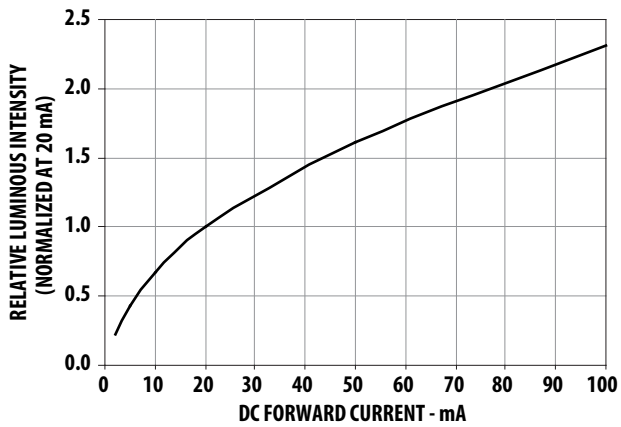


Figure 4. Relative Luminous Intensity vs. Forward Current

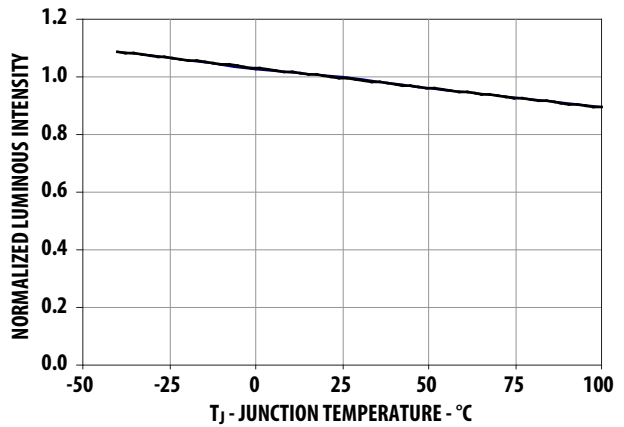


Figure 5. Relative Intensity vs. Temperature

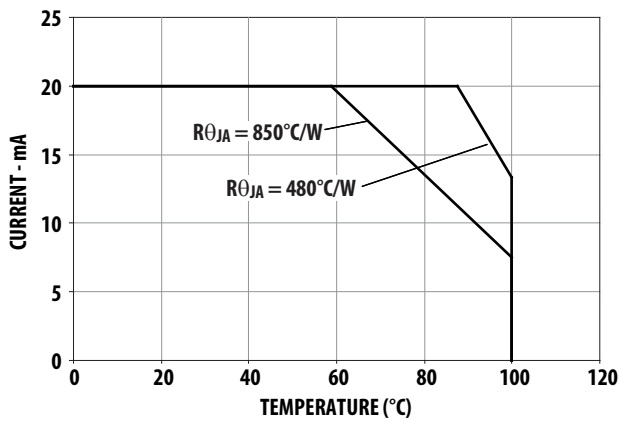


Figure 6. Maximum Forward Current Vs. Ambient Temperature. Derate Based on $T_{JMAX} = 110^{\circ}C$, $R_{\theta JA} = 850^{\circ}C/W$, $480^{\circ}C/W$.

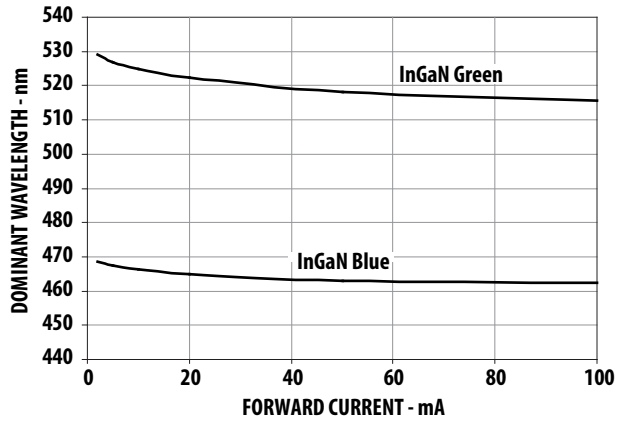


Figure 7. Dominant Wavelength Shift vs. Forward Current

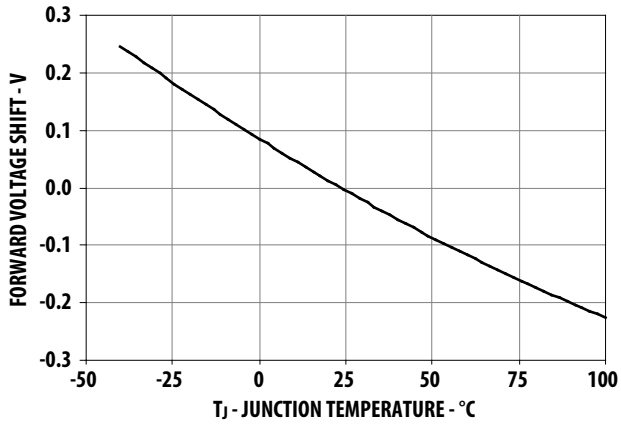


Figure 8. Forward Voltage Shift vs. Temperature.

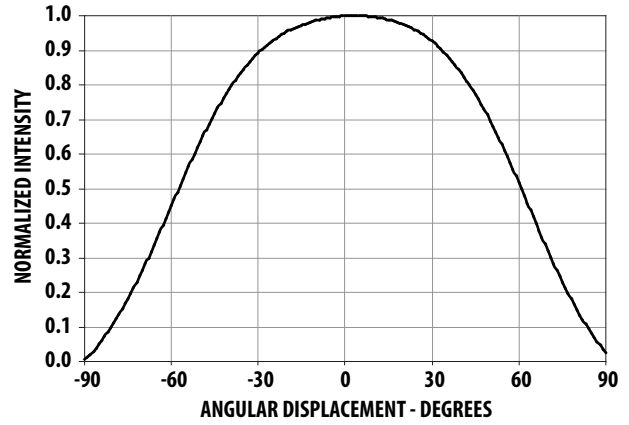


Figure 9. Radiation Pattern

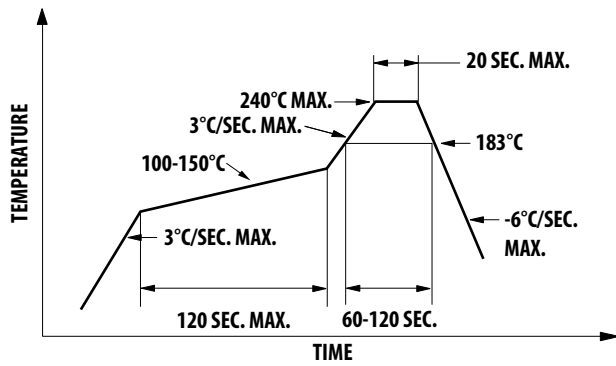
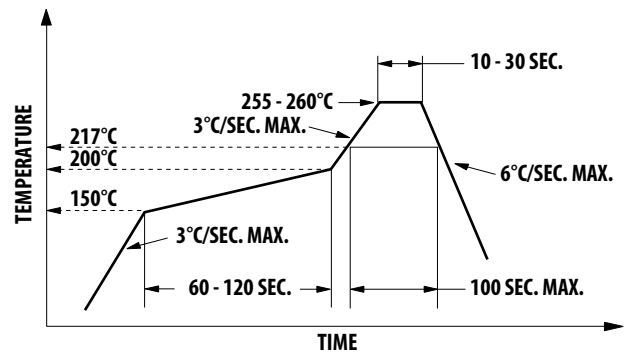


Figure 10a. Recommended SnPb Reflow Soldering Profile.



(Acc. to J-STD-020C)

Figure 10b. Recommended Pb-Free Reflow Soldering Profile.

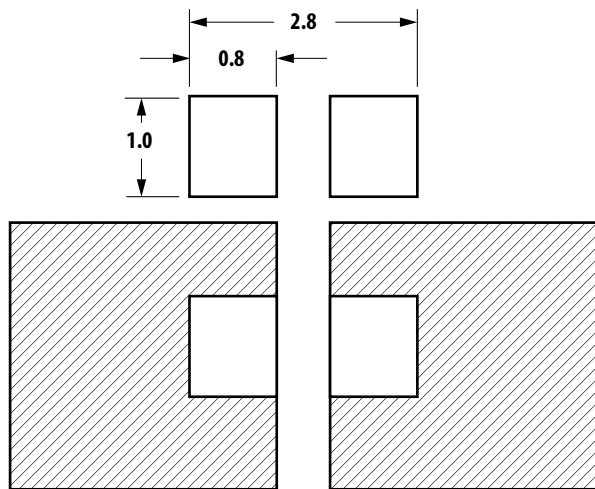


Figure 11. Recommended Soldering Pad Pattern.

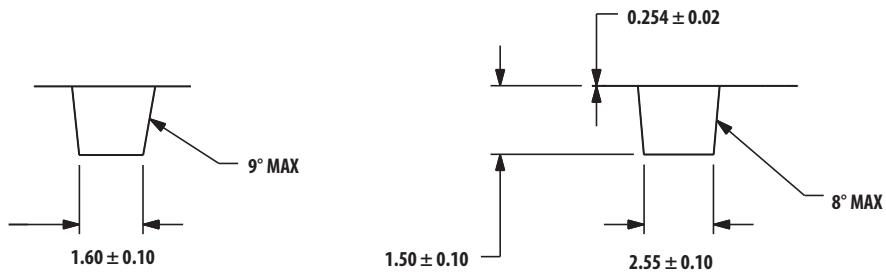
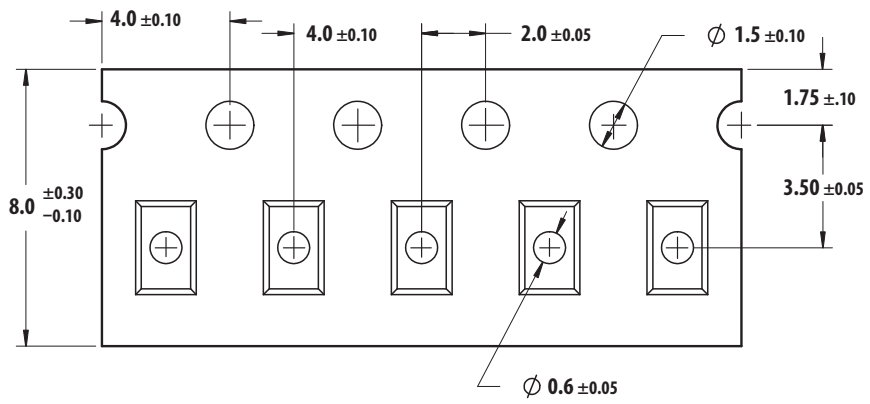


Figure 12. Tape Leader and Trailer Dimensions.

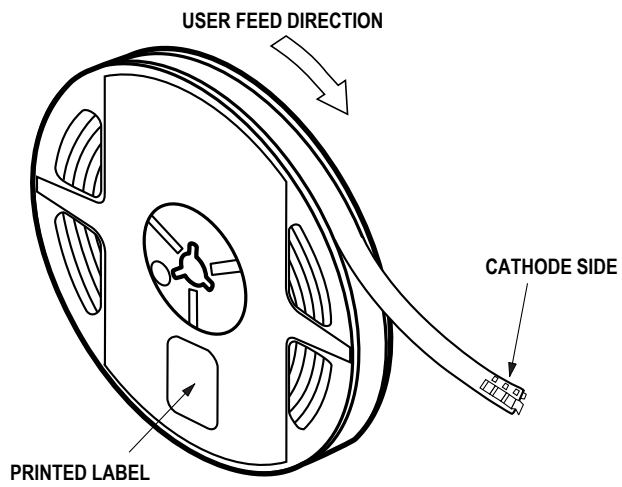


Figure 13. Reeling Orientation.

Handling Precaution

The encapsulation material of the product is made of silicone for better reliability of the product. As silicone is a soft material, please do not press on the silicone or poke a sharp object onto the silicone. These might damage the product and cause premature failure. During assembly or handling, the unit should be held on the body only. Please refer to Avago Application Note AN 5288 for detail information.

Moisture Sensitivity

This product is qualified as Moisture Sensitive Level 2a per Jedec J-STD-020. Precautions when handling this moisture sensitive product is important to ensure the reliability of the product. Do refer to Avago Application Note AN5305 Handling of Moisture Sensitive Surface Mount Devices for details.

A. Storage before use

- Unopen moisture barrier bag (MBB) can be stored at <math><40^{\circ}\text{C}/90\%\text{RH}</math> for 12 months. If the actual shelf life has exceeded 12 months and the HIC indicates that baking is not required, then it is safe to reflow the LEDs per the original MSL rating.
- It is not recommended to open the MBB prior to assembly (e.g. for IQC).

B. Control after opening the MBB

- The humidity indicator card (HIC) shall be read immediately upon opening of MBB.
- The LEDs must be kept at <math><30^{\circ}\text{C} / 60\%\text{RH}</math> at all time and all high temperature related process including soldering, curing or rework need to be completed within 672 hours.

C. Control for unfinished reel

- For any unused LEDs, they need to be stored in sealed MBB with desiccant or desiccator at <math><5\%\text{RH}</math>.

D. Control of assembled boards

- If the PCB soldered with the LEDs is to be subjected to other high temperature processes, the PCB need to be stored in sealed MBB with desiccant or desiccator at <math><5\%\text{RH}</math> to ensure no LEDs have exceeded their floor life of 672 hours.

E. Baking is required if:

- The HIC indicator is not GREEN at 10% and is AZURE at 5%
- The LEDs are exposed to condition of $>30^{\circ}\text{C} / 60\%\text{RH}$ at any time.
- The LEDs floor life exceeded 672 hours.

Recommended baking condition: $60\pm 5^{\circ}\text{C}$ for 20hrs

Device Color (X₁)

B	Blue
G	Green

Intensity Bin Select (X₂X₃)

Individual reel will contain parts from one half bin only

X ₂	Min I _v Bin
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X₃

0	Full Distribution
2	2 half bins starting from X ₂ 1
3	3 half bins starting from X ₂ 1
4	4 half bins starting from X ₂ 1
5	5 half bins starting from X ₂ 1
6	2 half bins starting from X ₂ 2
7	3 half bins starting from X ₂ 2
8	4 half bins starting from X ₂ 2
9	5 half bins starting from X ₂ 2

Intensity Bin Limits

Bin ID	Min. (mcd)	Max. (mcd)
P1	45.0	56.0
P2	56.0	71.5
Q1	71.5	90.0
Q2	90.0	112.5
R1	112.5	140.0
R2	140.0	180.0
S1	180.0	224.0
S2	224.0	285.0
T1	285.0	355.0
T2	355.0	450.0
U1	450.0	560.0
U2	560.0	715.0
V1	715.0	900.0
V2	900.0	1125.0

Tolerance of each bin limit = ± 12%

Color Bin Select (X₄)

Individual reel will contain parts from one sub bin only.

X₄

0	Full Distribution
A	1 and 2 only
B	2 and 3 only
C	3 and 4 only
G	1, 2 and 3 only
H	2, 3 and 4 only
Z	Special binning

Color Bin Limits

Blue	Min. (nm)	Max. (nm)
1	460.0	465.0
2	465.0	470.0
3	470.0	475.0
4	475.0	480.0

Green	Min. (nm)	Max. (nm)
1	515.0	520.0
2	520.0	525.0
3	525.0	530.0
4	530.0	535.0

Tolerance of each bin limit = ±1 nm

Packaging Option (X₅)

Option	Test Current	Package Type	Reel Size
2	20 mA	Top Mount	7 Inch

For product information and a complete list of distributors, please go to our web site: www.avagotech.com

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